



VMDSEMI

**VTTL050R15BNB**

**Datasheet**

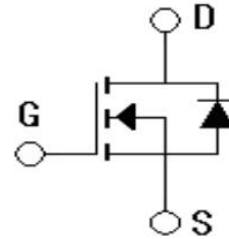


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## General Description

## Symbol

$V_{(BR)DSS}$	$R_{DS(ON)_{max}}$	$I_D$
500V	1.55Ω@10V	5A



Symbol of VTTL050R15BNB

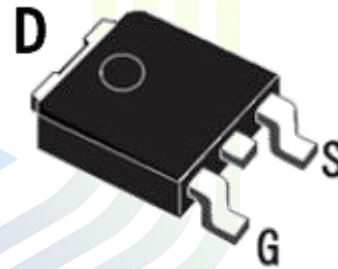
## Features

- Low Gate Charge
- Low Crss
- Advanced Planar Process
- Rugged Poly silicon Gate Structure

## Application

- BLDC Motor Driver
- UPS
- Electric Welder
- High Efficiency SMPS

## Package Type



## TO-252

Package Type of VTTL050R15BNB

## Ordering Information

Product Name	Package
VTTL050R15BNB	TO-252

**Absolute Maximum Ratings** ( $T_J = 25\text{ }^\circ\text{C}$ , unless otherwise specified)

Parameter	Symbol	Rating	Unit
Drain-Source Voltage	$V_{DSS}$	500	V
Gate-Source Voltage	$V_{GSS}$	$\pm 30$	V
Continuous Drain Current $T_C = 25\text{ }^\circ\text{C}$	$I_D$	5	A
Pulsed Drain Current@ $V_{GS}=10\text{V}$ <sup>Note1</sup>	$I_{DM}$	15	
Single Pulsed Avalanche Energy	$E_{AS}$	80	mJ
Total Power Dissipation $T_C = 25\text{ }^\circ\text{C}$	$P_D$	45	W
Derating Factor above 25°C		0.36	0.36W/°C
Junction Temperature	$T_J$	150	°C
Storage Temperature	$T_{STG}$	-55 to 150	°C
Maximum Lead Temperature for Soldering Purposes	$T_L$	300	°C

**Thermal Resistance**

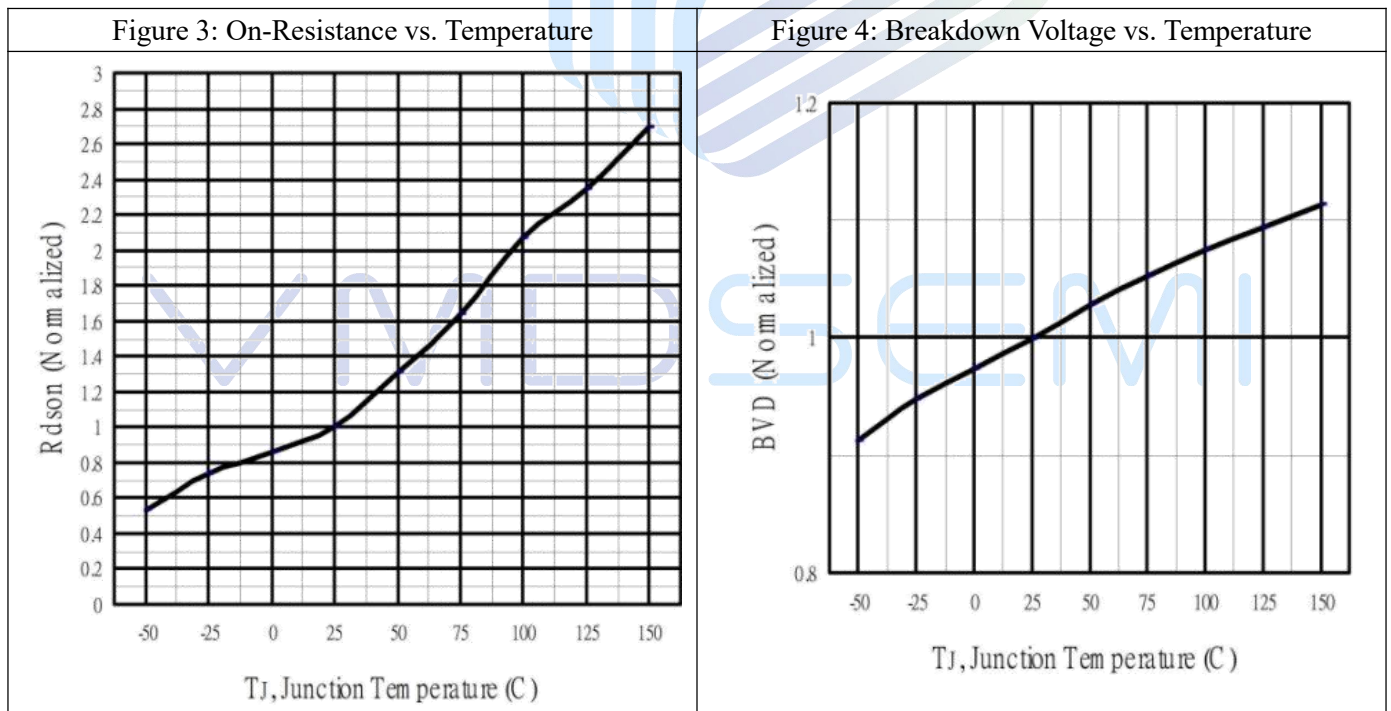
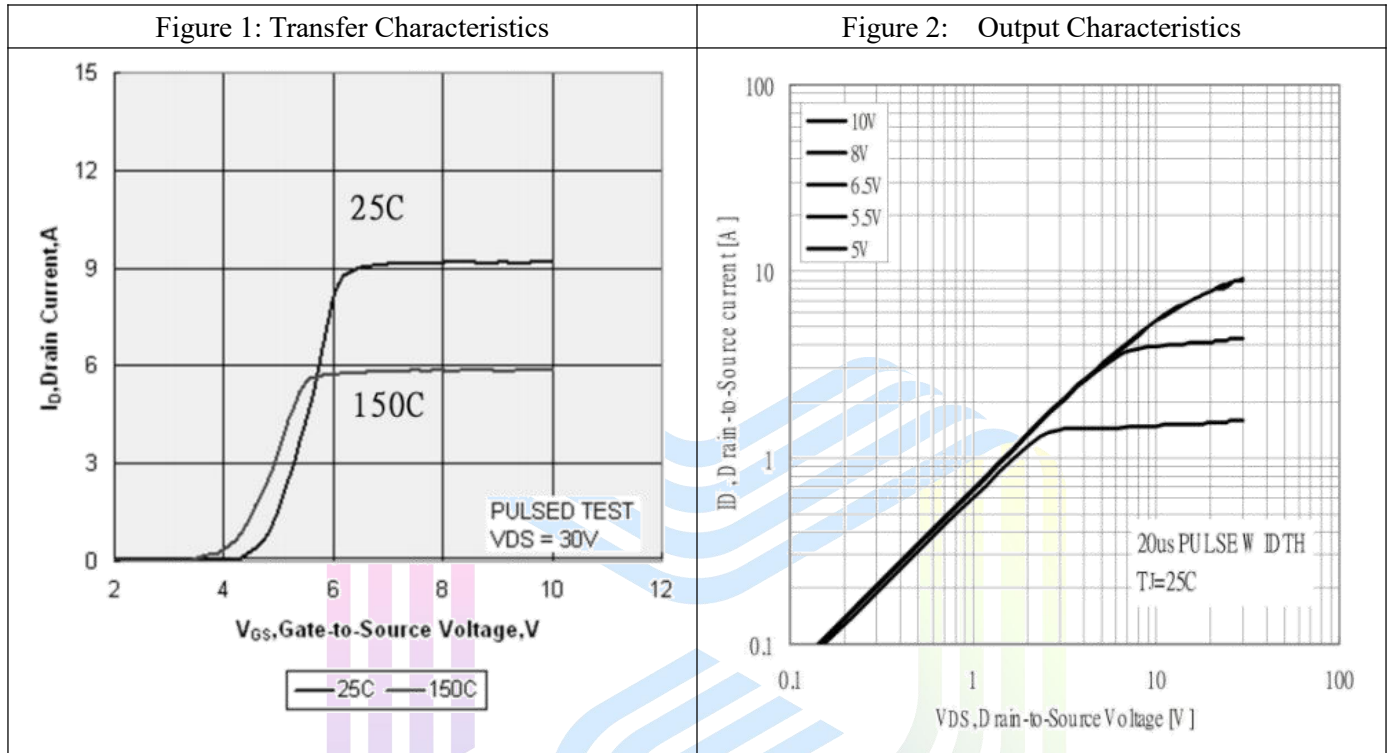
Parameter	Symbol	Min	Typ	Max	Unit
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$		62.5		°C/W
Thermal Resistance, Junction-to-Case	$R_{\theta JC}$		2.8		°C/W

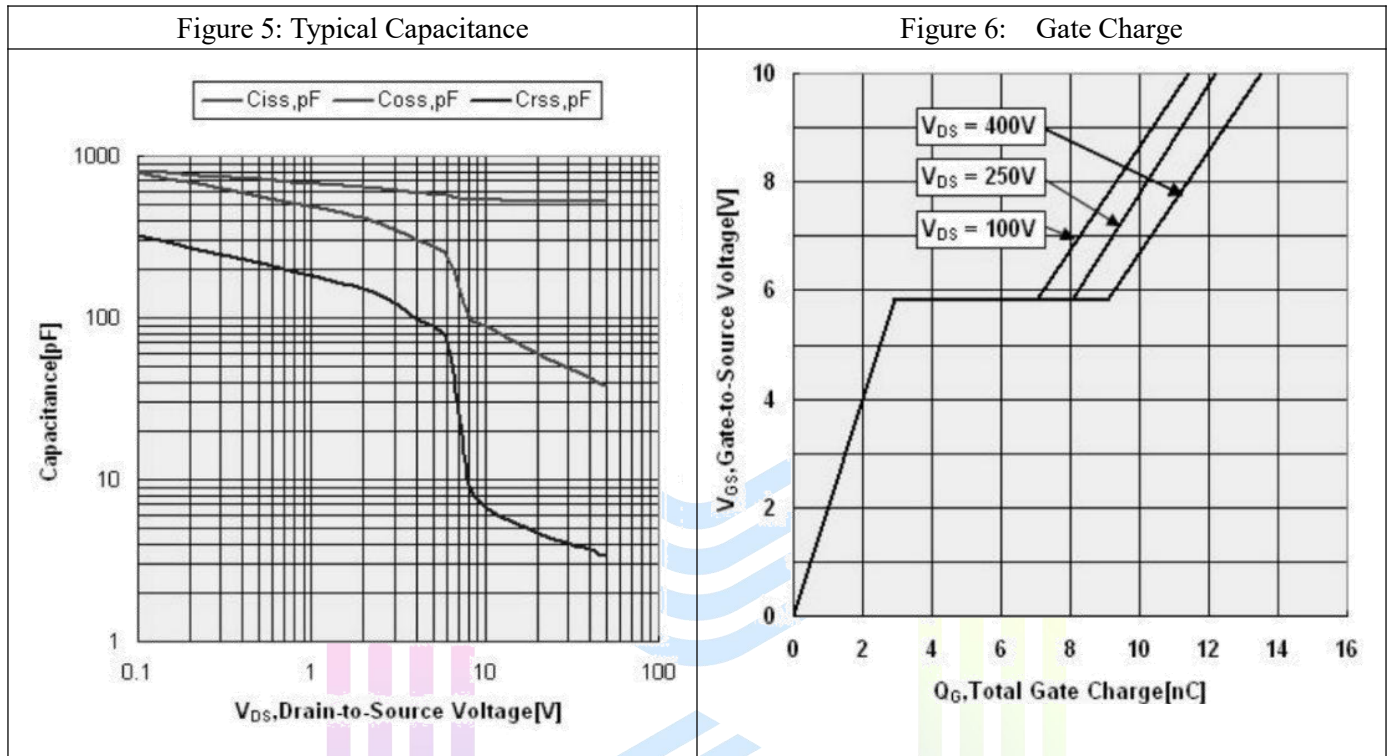
**Electrical Characteristics** ( $T_J = 25\text{ }^\circ\text{C}$ , unless otherwise specified)

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
<b>Statistic Characteristics</b>						
Drain-Source Breakdown Voltage	$BV_{DSS}$	$V_{GS}=0V, I_D=250\mu A$	500	-	-	V
Zero Gate Voltage Drain Current	$I_{DSS}$	$V_{DS}=500V, V_{GS}=0V$	-	-	1	uA
		$V_{DS}=400V, V_{GS}=0V$ $T_J=125\text{ }^\circ\text{C}$	-	-	100	
Gate-Body Leakage Current	$I_{GSS}$	$V_{GS} = \pm 30V, V_{DS}=0V$	-	-	$\pm 100$	nA
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}, I_D=250\mu A$	2.5	-	4.5	V
Static Drain-Source On-Resistance	$R_{DS(ON)}$	$V_{GS}=10V, I_D=2.5A$	-	-	1.55	$\Omega$
<b>Dynamic Characteristics</b>						
Input Capacitance	$C_{ISS}$	$V_{DS}=25V$	-	528	-	pF
Output Capacitance	$C_{OSS}$	$V_{GS}=0V$	-	52	-	pF
Reverse Transfer Capacitance	$C_{RSS}$	$f=1MHz$	-	4	-	pF
<b>Switching Parameters</b>						
Total Gate Charge	$Q_g$	$V_{DS}=400V$	-	13	-	nC
Gate-Source Charge	$Q_{gs}$	$V_{GS}=0\text{ to }10V$	-	3	-	
Gate-Drain Charge	$Q_{gd}$	$I_D=5A$	-	6.2	-	
Turn-on Delay Time	$t_{d(on)}$	$V_{DD}=250V$	-	14	-	ns
Turn-on Rise Time	$t_r$	$V_{GS}=10V$	-	15	-	
Turn-off Delay Time	$t_{d(off)}$	$I_D=5A$	-	29	-	
Turn-off Fall Time	$t_f$	$R_G=25\Omega$	-	12	-	
<b>Diode Characteristics</b>						
Diode Forward Voltage	$V_{SD}$	$V_{GS}=0V, I_{SD}=5A$	-	-	1.5	V
Pulsed Source Current <sup>Note2</sup>	$I_{SD}$	Body Diode	-	-	5	A
Diode Forward Voltage <sup>Note2</sup>	$I_{SM}$		-	-	15	
Reverse recovery time	$t_{rr}$	$V_{GS}=0V, I_{SD}=5A$ $di/dt=100A/\mu s$	-	213	-	ns

Notes:

1. Pulse width limited by maximum junction
2. Pulse Test: Pulse Width  $\leq 380\mu s$ , Duty Cycle  $\leq 2\%$

**Typical Performance Characteristics**




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